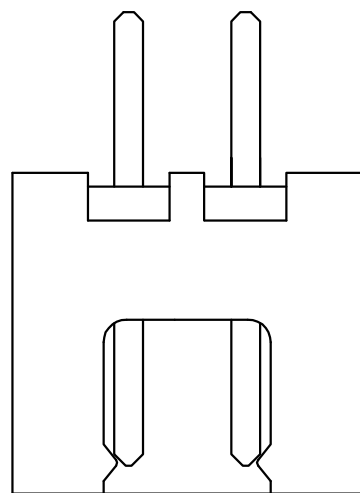
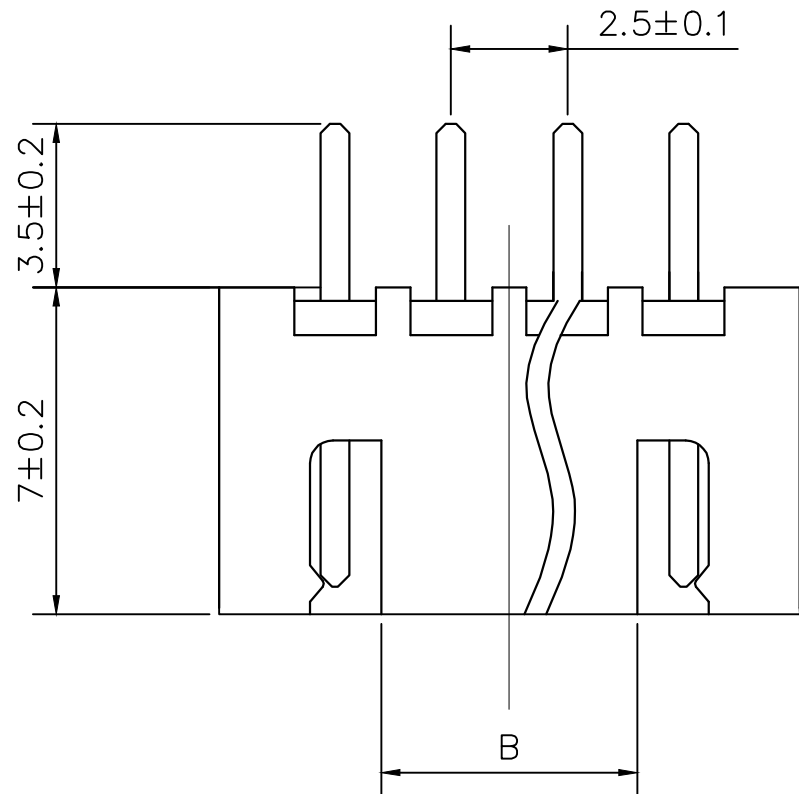


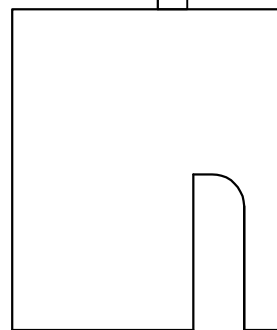
标记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修改 REVISE	日期 DATE	核准 APPROVE

Pin	DIM A	DIM B
2	7.50	0.00
3	10.00	2.50
4	12.50	5.00
5	15.00	7.50
6	17.50	10.00
7	20.00	12.50
8	22.50	15.00
9	25.00	17.50
10	27.50	20.00
11	30.00	22.50
12	32.50	25.00
13	35.00	27.50
14	37.50	30.00
15	40.00	32.50
16	42.50	35.00



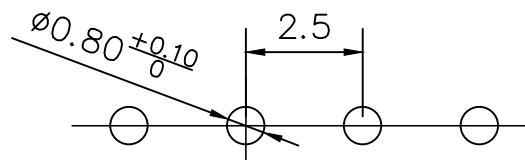
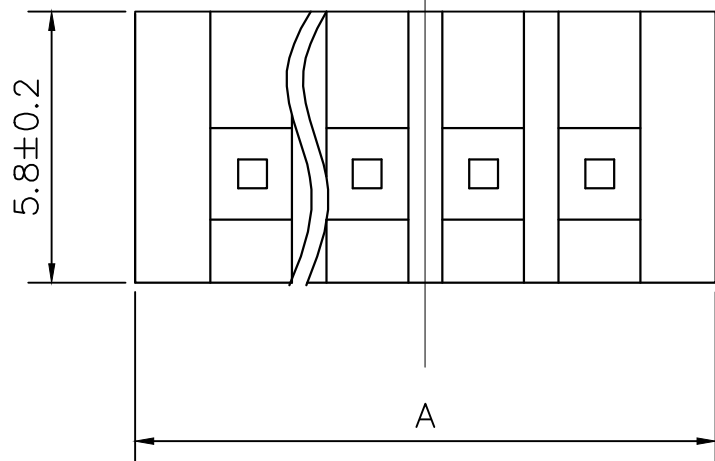
2PIN

0.63±0.05




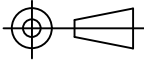
技术要求:

适应基板厚度: 1.2mm~1.6mm
 温度范围: -25°C~85°C
 额定电压: 250V AC/DC
 额定电流: 3A
 接触电阻: ≤0.01Ω
 绝缘电阻: ≥1000MΩ
 耐 压: 1000V AC/minute



PCB LAYOUT

2	插针	铜	镀锡	
1	基座	PA66	米色	
序号	品名	材质	电镀/颜色	备注

 深圳市虹成电子有限公司 品名 TITLE 针座 料号 PART NO HCZZ0126-7		比列 SCALE 1:1			
		GENERAL TOLERANCES (UNLESS SPECIFIED) X.X ±0.35 X' ±3.00' X.XX ±0.25 X.X' ±2.00' X.XXX ±0.15 X.XX' ±1.00'	单位 UNIT MM 张数 PART NO 1 OF 1 版本 REV A	制图 DRAW AhYe 审核 CHECKED 夏操云 批准 APPROVE 赵亮亮	